



12V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
	16mΩ @ V _{GS} = -4.5V	-9.1A
1011	21.5mΩ @ V _{GS} = -2.5V	-7.9A
-12V	26mΩ @ V _{GS} = -1.8V	-7.0A
	32mΩ @ V _{GS} = -1.5V	-6.3A

Description

This MOSFET is designed specifically for use in battery management applications.

Pin1

Features

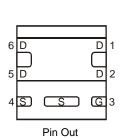
- 0.6mm Profile Ideal For Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected to 3KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

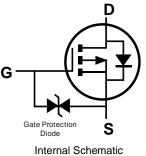
Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.0065 grams (Approximate)



U-DFN2020-6





Bottom View

Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per reel
DMP1022UFDE-7	P4	7	3,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

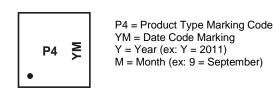
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Bottom View

Marking Information



Date Code Key

Notes:

Date Code Rey			-									
Year	2011	~	2015	2016	5 201	7 20	018	2019	2020	2021	2022	2023
Code	Y	~	С	D	E		F	G	Н		J	K
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	J Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage		V _{DSS}	-12	V	
Gate-Source Voltage			V _{GSS}	±8	V
	Steady State	T _A = +25°C T _A = +70°C	ID	-9.1 -7.2	А
Continuous Drain Current (Note 6) $V_{GS} = -4.5V$	t<5s	T _A = +25°C T _A = +70°C	ID	-11.2 -9.0	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I _{DM}	-90	А	
Continuous Source-Drain Diode Current	$T_{A} = +25^{\circ}C$ $T_{C} = +25^{\circ}C$	ls	-2.5 -7.1	А	
Pulsed Source-Drain Diode Current (10µs pulse, dut	I _{SM}	-50	А		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Dawar Dissinction (Nata 5)	T _A = +25°C	D	0.66	W	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.42	vv	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Paul	189	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<5s	R _{θJA}	123	0/10	
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.03	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD	1.3		
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	Devi	61		
memai Resistance, Junction to Ambient (Note 6)	t<5s	R _{0JA}	40	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady state	R _{θJC}	9.3		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1-inch square copper plate

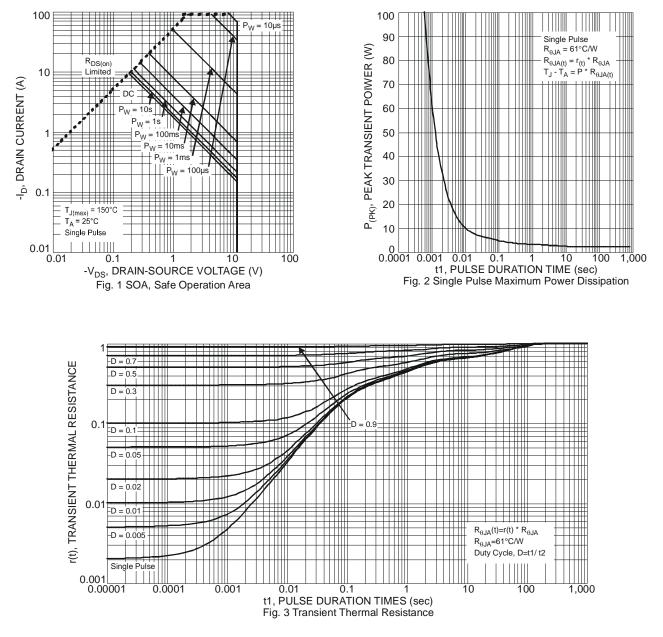


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

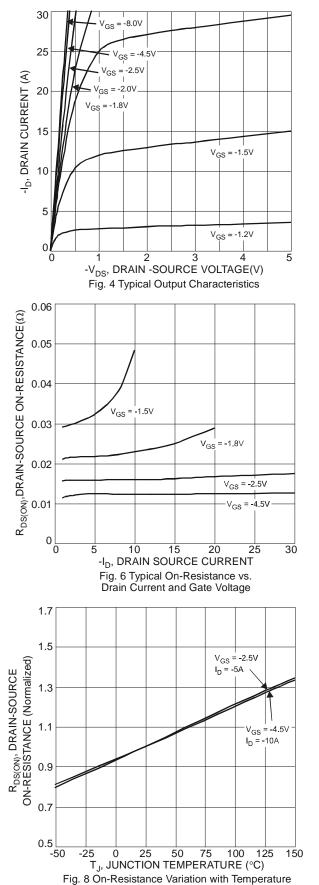
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	тур	IVIAN	Unit	Test condition
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current ($T_J = +25^{\circ}C$)	I _{DSS}	_	_	-200	nA	$V_{DS} = -12V, V_{GS} = 0V$
Zero Gate Voltage Drain Current ($T_J = +55^{\circ}C$) (Note 8)	IDSS	_	_	-2	μA	$V_{DS} = -12V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±2	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)	000					
Gate Threshold Voltage	V _{GS(th)}	-0.35	—	-0.8	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)} / \Delta T_J$	_	2.5	—	mV/°C	I _D = -250µA
On-State Drain Current	I _{D(ON)}	-10	_	—	А	V _{GS} = -4.5V, V _{DS} < -5A
	-()		12	16		$V_{GS} = -4.5V, I_D = -8.2A$
			15	21.5		V _{GS} = -2.5V, I _D = -7.2A
Static Drain-Source On-Resistance	R _{DS(ON)}	—	20	26	mΩ	V _{GS} = -1.8V, I _D = -6.6A
	- (-)		23	32		V _{GS} = -1.5V, I _D = -1A
			80	160		V _{GS} = -1.2V, I _D = -1A
Forward Transfer Admittance	Y _{fs}		12	_	S	$V_{DS} = -4V, I_D = -8.2A$
Diode Forward Voltage	V _{SD}		-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -8A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		2,953	—		
Output Capacitance	Coss	_	756	—	pF	$V_{DS} = -4V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	678	—		1 = 1.000112
Gate Resistance	Rg	_	8.6	18	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	_	28.4	42.6		$V_{GS} = -5V, V_{DS} = -4, I_D = -10A$
Total Gate Charge	Qg	_	25.3	38	-0	
Gate-Source Charge	Q _{gs}	_	2.3	—	nC	$V_{GS} = -4.5V, V_{DS} = -4V,$
Gate-Drain Charge	Q _{qd}	_	7.2	—		I _D = -10A
Turn-On Delay Time	t _{D(on)}		20	30		
Turn-On Rise Time	tr	_	28	42	nS	$V_{DS} = -4V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}		117	176	ns	$R_{G} = 1\Omega, R_{L} = 0.4\Omega, I_{D} = -9.8A$
Turn-Off Fall Time	tf	_	93	139		
BODY DIODE CHARACTERISTICS						
Diode Forward Voltage	V _{SD}		-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -9.8A$
Continuous Source Drain Diade Current (Note 6)		_	_	-2.5		$T_A = +25^{\circ}C$
Continuous Source-Drain Diode Current (Note 6)	IS	_	_	-7.1	А	$T_{\rm C}$ = +25°C
Pulse Diode Forward Current (Note 8)	I _{SM}	_		-50		—
Bodyy Diode Reverse Recovery Time (Note 8)	t _{rr}	_	28	56		
Reverse Recovery Fall Time	ta	_	10	—	nS	
Reverse Recovery Rise Time	tb	—	18	—		$I_{S} = -9.8A$, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge (Note 8)	Q _{rr}	—	13	26	nC	1

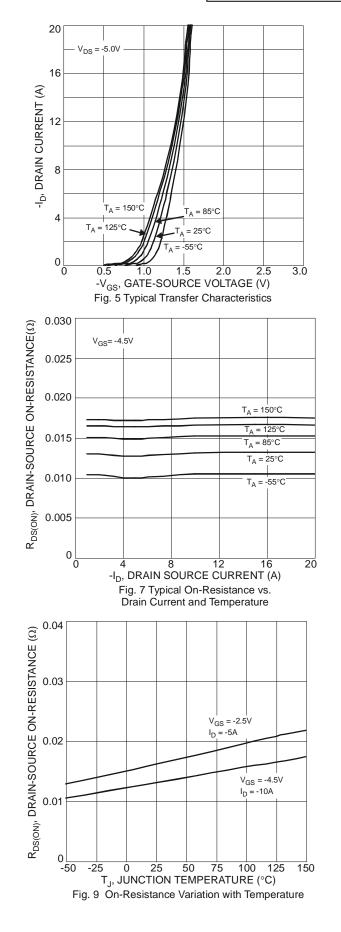
 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing. Notes:



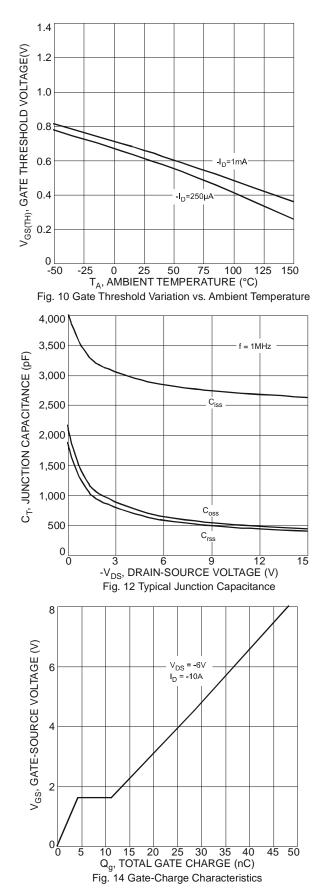


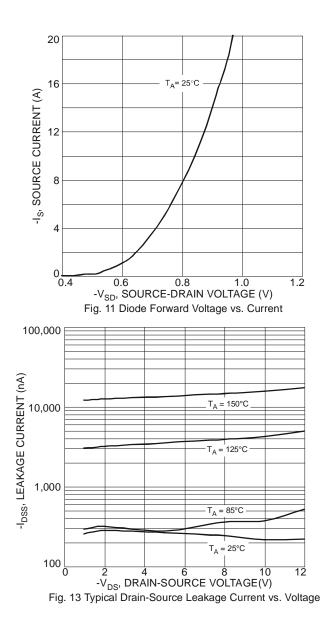








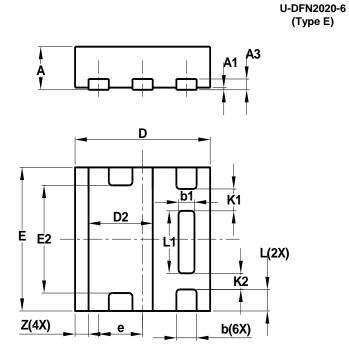






Package Outline Dimensions

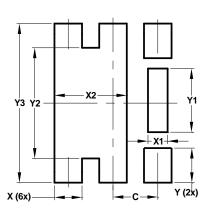
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



U-DFN2020-6 (Type E)							
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0	0.05	0.03				
A3	-	-	0.15				
b	0.25	0.35	0.30				
b1	0.185	0.285	0.235				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
Е	1.95	2.05	2.00				
E2	1.40	1.60	1.50				
e	-	-	0.65				
L	0.25	0.35	0.30				
L1	0.82	0.92	0.87				
K1	-	-	0.305				
K2	-	-	0.225				
Z	_	_	0.20				
All	Dimens	ions in	mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



U-DFN2020-6 (Type E)

Dimensions	Value (in mm)
С	0.650
Х	0.400
X1	0.285
X2	1.050
Y	0.500
Y1	0.920
Y2	1.600
Y3	2.300



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